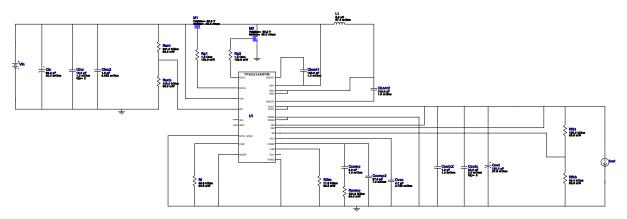
VinMin = 5.0V VinMax = 36.0V Vout = 5.0V Iout = 2.0A Device = TPS55288RPMR Topology = Buck\_Boost Created = 2023-10-09 19:23:15.504 BOM Cost = \$6.79 BOM Count = 27 Total Pd = 0.45W

# WEBENCH® Design Report

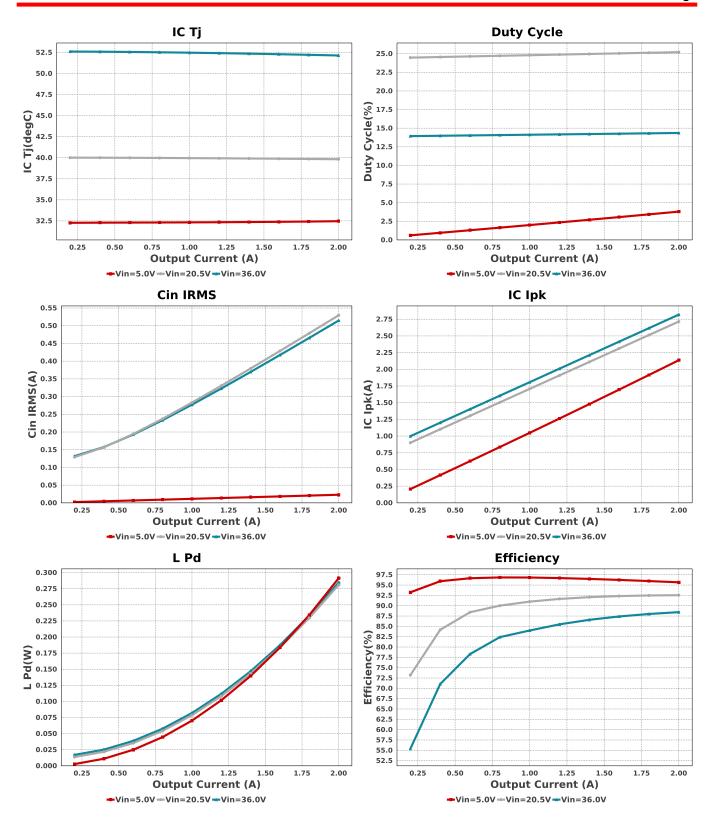
Design: 1 TPS55288RPMR TPS55288RPMR 5V-36V to 5.00V @ 2A

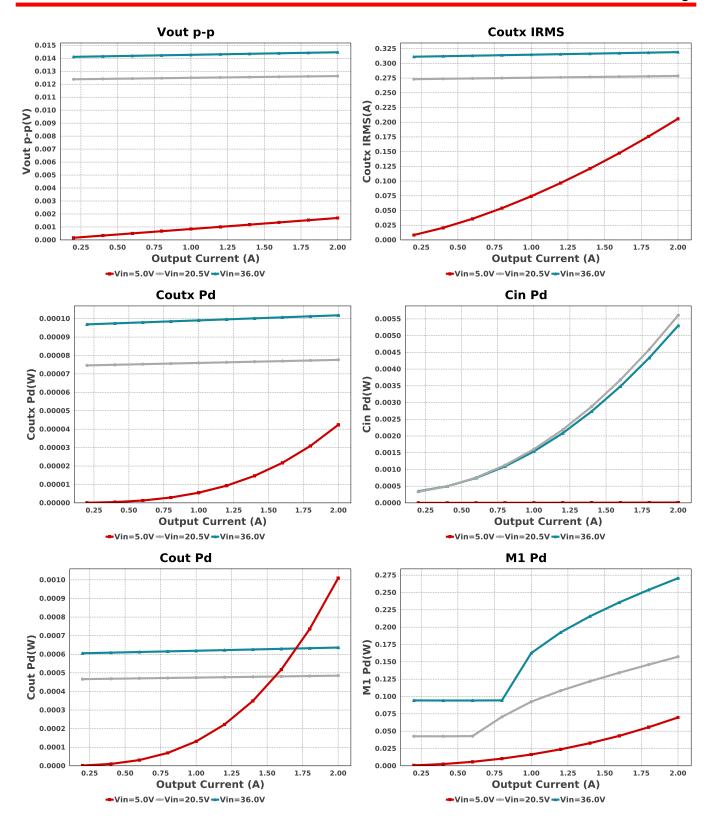


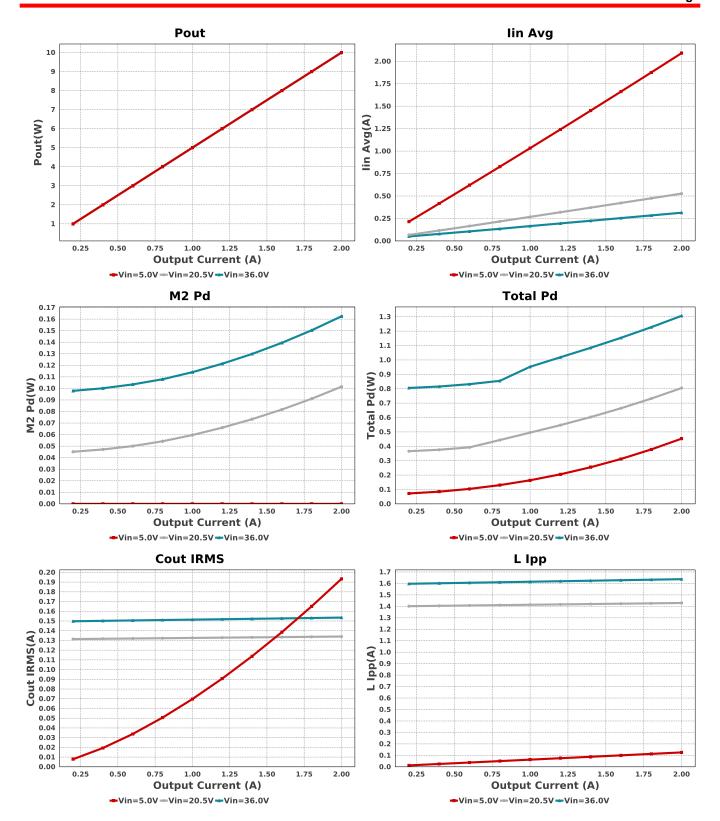
### **Electrical BOM**

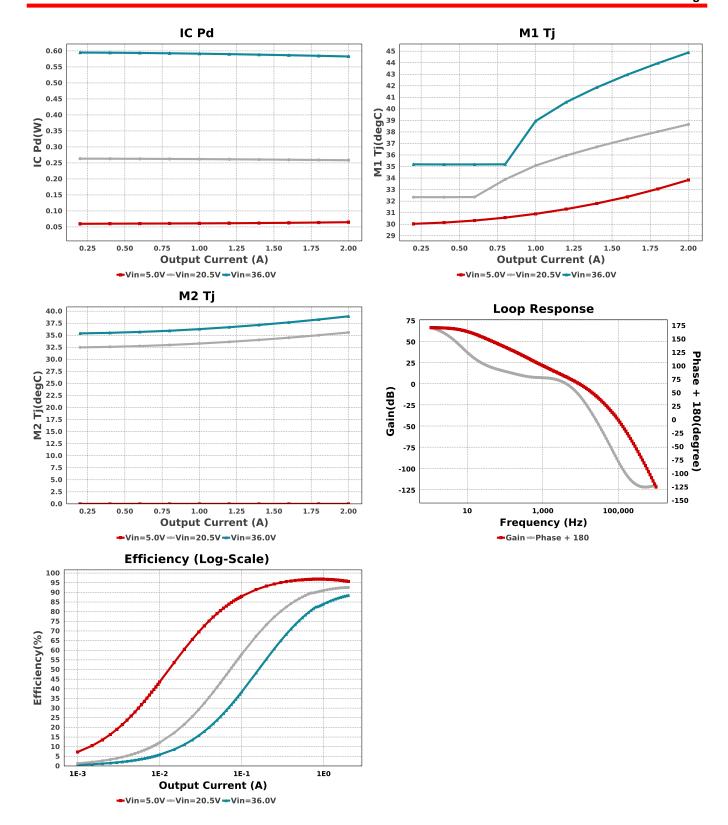
Name	Manufacturer	Part Number	Properties	Qty	Price	Footprint
Cboot1	Taiyo Yuden	EMK107B7104KA-T Series= X7R	Cap= 100.0 nF ESR= 1.0 mOhm VDC= 16.0 V IRMS= 0.0 A	1	\$0.01	0603 5 mm <sup>2</sup>
Cboot2	Taiyo Yuden	EMK107B7104KA-T Series= X7R	Cap= 100.0 nF ESR= 1.0 mOhm VDC= 16.0 V IRMS= 0.0 A	1	\$0.01	0603 5 mm <sup>2</sup>
Ccomp	MuRata	GRM155R71C222KA01D Series= X7R	Cap= 2.2 nF ESR= 1.0 mOhm VDC= 16.0 V IRMS= 0.0 A	1	\$0.01	0402 3 mm <sup>2</sup>
Ccomp2	MuRata	GRM1555C1H270JA01D Series= C0G/NP0	Cap= 27.0 pF ESR= 1.0 mOhm VDC= 50.0 V IRMS= 0.0 A	1	\$0.01	0402 3 mm <sup>2</sup>
Cin	Panasonic	50SVPF68M Series= SVPF	Cap= 68.0 uF ESR= 20.0 mOhm VDC= 50.0 V IRMS= 4.3 A	1	\$1.57	CAPSMT_62_F12 151 mm <sup>2</sup>
Cinx	TDK	C3225X7R1H106M250AC Series= X7R	Cap= 10.0 uF ESR= 1.0 mOhm VDC= 50.0 V IRMS= 5.0 A	2	\$0.27	1210 15 mm <sup>2</sup>
Cinx2	TDK	C1608X5R1H105K080AB Series= X5R	Cap= 1.0 uF ESR= 5.522 mOhm VDC= 50.0 V IRMS= 2.2162 A	1	\$0.03	0603 5 mm <sup>2</sup>
Cout	Panasonic	10SVPC120M Series= SVPC	Cap= 120.0 uF ESR= 27.0 mOhm VDC= 10.0 V IRMS= 2.32 A	1	\$0.46	SM_RADIAL_6.3AMM 80 mm <sup>2</sup>
Coutx	MuRata	GRM21BR61A226ME44L Series= X5R	Cap= 22.0 uF ESR= 3.0 mOhm VDC= 10.0 V IRMS= 3.84 A	3	\$0.09	0805 7 mm <sup>2</sup>

Name	Manufacturer	Part Number	Properties	Qty	Price	Footprint
Coutx2	Kemet	C0603C105Z8VACTU Series= Y5V	Cap= 1.0 uF ESR= 1.0 mOhm VDC= 10.0 V IRMS= 0.0 A	1	\$0.01	0603 5 mm <sup>2</sup>
Cvcc	TDK	C1608X6S1C475K080AC Series= X6S	Cap= 4.7 uF ESR= 3.728 mOhm VDC= 16.0 V IRMS= 2.69359 A	1	\$0.08	0603 5 mm <sup>2</sup>
L1	Coilcraft	XAL4030-682MEB	L= 6.8 μH 67.4 mOhm	1	\$0.72	XAL4030 25 mm <sup>2</sup>
M1	Texas Instruments	CSD18543Q3A	VdsMax= 60.0 V IdsMax= 35.0 Amps	1	\$0.23	DNH0008A 18 mm <sup>2</sup>
M2	Texas Instruments	CSD18543Q3A	VdsMax= 60.0 V IdsMax= 35.0 Amps	1	\$0.23	DNH0008A 18 mm <sup>2</sup>
Rcomp	Vishay-Dale	CRCW0402124KFKED Series= CRCWe3	Res= 124.0 kOhm Power= 63.0 mW Tolerance= 1.0%	1	\$0.01	0402 3 mm <sup>2</sup>
Renb	Vishay-Dale	CRCW0402100KFKED Series= CRCWe3	Res= 100.0 kOhm Power= 63.0 mW Tolerance= 1.0%	1	\$0.01	0402 3 mm <sup>2</sup>
Rent	Vishay-Dale	CRCW0402301KFKED Series= CRCWe3	Res= 301.0 kOhm Power= 63.0 mW Tolerance= 1.0%	1	\$0.01	0402 3 mm <sup>2</sup>
Rfbb	Vishay-Dale	CRCW040229K4FKED Series= CRCWe3	Res= 29.4 kOhm Power= 63.0 mW Tolerance= 1.0%	1	\$0.01	0402 3 mm <sup>2</sup>
Rfbt	Vishay-Dale	CRCW0402100KFKED Series= CRCWe3	Res= 100.0 kOhm Power= 63.0 mW Tolerance= 1.0%	1	\$0.01	0402 3 mm <sup>2</sup>
Rg1	Vishay-Dale	CRCW06031R00FKEA Series= CRCWe3	Res= 1.0 Ohm Power= 100.0 mW Tolerance= 1.0%	1	\$0.01	0603 5 mm <sup>2</sup>
Rg2	Vishay-Dale	CRCW06031R00FKEA Series= CRCWe3	Res= 1.0 Ohm Power= 100.0 mW Tolerance= 1.0%	1	\$0.01	0603 5 mm <sup>2</sup>
Rilim	Vishay-Dale	CRCW040271K5FKED Series= CRCWe3	Res= 71.5 kOhm Power= 63.0 mW Tolerance= 1.0%	1	\$0.01	0402 3 mm <sup>2</sup>
Rt	Vishay-Dale	CRCW040249K9FKED Series= CRCWe3	Res= 49.9 kOhm Power= 63.0 mW Tolerance= 1.0%	1	\$0.01	0402 3 mm <sup>2</sup>
U1	Texas Instruments	TPS55288RPMR	Switcher	1	\$2.52	RPM0026A 22 mm <sup>2</sup>









## Operating Values

#	Name	Value	Category	Description
1.	Cin IRMS	22.924 mA	Capacitor	Input capacitor RMS ripple current
2.	Cin Pd	10.51 μW	Capacitor	Input capacitor power dissipation
3.	Cout IRMS	193.299 mA	Capacitor	Output capacitor RMS ripple current
4.	Cout Pd	1.009 mW	Capacitor	Output capacitor power dissipation
5.	Coutx IRMS	205.853 mA	Capacitor	Output capacitor_x RMS ripple current
6.	Coutx Pd	42.376 μW	Capacitor	Output capacitor_x power loss
7.	IC lpk	2.136 A	IC	Peak switch current in IC
8.	IC Pd	64.807 mW	IC	IC power dissipation
9.	IC Tj	32.463 degC	IC	IC junction temperature
10.	IC Tolerance	12.0 mV	IC	IC Feedback Tolerance
11.	ICThetaJA Effective	38.0 degC/W	IC	Effective IC Junction-to-Ambient Thermal Resistance

#	Name	Value	Category	Description
12.	lin Avg	2.091 A	IC	Average input current
13.	L lpp	125.58 mA	Inductor	Peak-to-peak inductor ripple current
14.	L Pd	291.42 mW	Inductor	Inductor power dissipation
15.	M1 Pd	69.686 mW	Mosfet	M1 MOSFET total power dissipation
16.	M1 Tj	33.833 degC	Mosfet	M1 MOSFET junction temperature
17.	M2 Pd	0.0 W	Mosfet	M2 MOSFET total power dissipation
18.	M2 Tj	0.0 degC	Mosfet	M2 MOSFET junction temperature
19.	Cin Pd	10.51 μW	Power	Input capacitor power dissipation
20.	Cout Pd	1.009 mW	Power	Output capacitor power dissipation
21.	Coutx Pd	42.376 μW	Power	Output capacitor_x power loss
22.	IC Pd	64.807 mW	Power	IC power dissipation
23.	L Pd	291.42 mW	Power	Inductor power dissipation
24.	M1 Pd	69.686 mW	Power	M1 MOSFET total power dissipation
25.	M2 Pd	0.0 W	Power	M2 MOSFET total power dissipation
26.	Total Pd	453.033 mW	Power	Total Power Dissipation
27.	BOM Count	27	System	Total Design BOM count
			Information	
28.	Cross Freq	9.986 kHz	System	Bode plot crossover frequency
			Information	
29.	Duty Cycle	3.801 %	System	Duty cycle
			Information	0
30.	Efficiency	95.666 %	System	Steady state efficiency
0.4	E (D)	2	Information	T. 15 (B) (A) (BOM
31.	FootPrint	425.0 mm <sup>2</sup>	System	Total Foot Print Area of BOM components
20		400 007 1.11-	Information	Cuitabia a fra accessor
32.	Frequency	198.807 kHz	System	Switching frequency
22	Coin Mora	-13.165 dB	Information	Pada Diot Cain Margin
33.	Gain Marg	-13.100 UD	System Information	Bode Plot Gain Margin
34.	lout	2.0 A	System	lout operating point
34.	lout	2.0 A	Information	lout operating point
35.	Low Freq Gain	60.064 dB	System	Gain at 1Hz
00.	Low 1104 Cam	00.00+ dB	Information	Gain at 1112
36.	Mode	CCM	System	Conduction Mode
00.	Modo	00111	Information	ouridation mode
37.	Phase Marg	55.562 deg	System	Bode Plot Phase Margin
			Information	g
38.	Pout	10.0 W	System	Total output power
			Information	
39.	Total BOM	\$6.79	System	Total BOM Cost
			Information	
40.	Vin	5.0 V	System	Vin operating point
			Information	
41.	Vout	5.0 V	System	Operational Output Voltage
			Information	
42.	Vout Actual	1.241 V	System	Vout Actual calculated based on selected voltage divider resistors
			Information	
43.	Vout Tolerance	5.883 %	System	Vout Tolerance based on IC Tolerance (no load) and voltage divider
			Information	resistors if applicable
44.	Vout p-p	1.691 mV	System	Peak-to-peak output ripple voltage
			Information	
45.	Vref	d2	System	Register VREF
			Information	

## **Design Inputs**

Name	Value	Description	
lout	2.0	Maximum Output Current	
VinMax	36.0	Maximum input voltage	
VinMin	5.0	Minimum input voltage	
Vout	5.0	Output Voltage	
base_pn	TPS55288	Base Product Number	
source	DC	Input Source Type	
Ta	30.0	Ambient temperature	

### WEBENCH® Assembly

#### Component Testing

Some published data on components in datasheets such as Capacitor ESR and Inductor DC resistance is based on conservative values that will guarantee that the components always exceed the specification. For design purposes it is usually better to work with typical values. Since this data is not always available it is a good practice to measure the Capacitance and ESR values of Cin and Cout, and the inductance and DC resistance of L1 before assembly of the board. Any large discrepancies in values should be electrically simulated in WEBENCH to check for instabilities and thermally simulated in WebTHERM to make sure critical temperatures are not exceeded.

#### Soldering Component to Board

If board assembly is done in house it is best to tack down one terminal of a component on the board then solder the other terminal. For surface mount parts with large tabs, such as the DPAK, the tab on the back of the package should be pre-tinned with solder, then tacked into place by one of the pins. To solder the tab town to the board place the iron down on the board while resting against the tab, heating both surfaces simultaneously. Apply light pressure to the top of the plastic case until the solder flows around the part and the part is flush with the PCB. If the solder is not flowing around the board you may need a higher wattage iron (generally 25W to 30W is enough).

#### Initial Startup of Circuit

It is best to initially power up the board by setting the input supply voltage to the lowest operating input voltage 5.0V and set the input supply's current limit to zero. With the input supply off connect up the input supply to Vin and GND. Connect a digital volt meter and a load if needed to set the minimum lout of the design from Vout and GND. Turn on the input supply and slowly turn up the current limit on the input supply. If the voltage starts to rise on the input supply continue increasing the input supply current limit while watching the output voltage. If the current increases on the input supply, but the voltage remains near zero, then there may be a short or a component misplaced on the board. Power down the board and visually inspect for solder bridges and recheck the diode and capacitor polarities. Once the power supply circuit is operational then more extensive testing may include full load testing, transient load and line tests to compare with simulation results.

#### Load Testing

The setup is the same as the initial startup, except that an additional digital voltmeter is connected between Vin and GND, a load is connected between Vout and GND and a current meter is connected in series between Vout and the load. The load must be able to handle at least rated output power + 50% (7.5 watts for this design). Ideally the load is supplied in the form of a variable load test unit. It can also be done in the form of suitably large power resistors. When using an oscilloscope to measure waveforms on the prototype board, the ground leads of the oscilloscope probes should be as short as possible and the area of the loop formed by the ground lead should be kept to a minimum. This will help reduce ground lead inductance and eliminate EMI noise that is not actually present in the circuit.



#### **Design Assistance**

- 1. Master key: 6E0F9CDD295CDE47D1DB770768DEFDA5[v1]
- 2. TPS55288 Product Folder: http://www.ti.com/product/TPS55288: contains the data sheet and other resources.

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